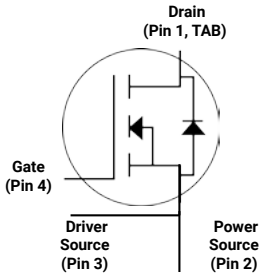
C3M0030090K

Silicon Carbide Power MOSFET C3M™ MOSFET Technology
N-Channel Enhancement Mode

Features

- C3M™ SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant



RoHS

Halogen-Free

Part Number	Package	Marking
C3M0030090K	TO-247-4	C3M0030090K

Wolfspeed, Inc. is in the process of rebranding its products and related materials pursuant to the entity name change from Cree, Inc. to Wolfspeed, Inc. During this transition period, products received may be marked with either the Cree name and/or logo or the Wolfspeed name and/or logo.

Typical Applications

- Solar inverters
- EV battery chargers
- High voltage DC/DC converters
- Switch Mode Power Supplies

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Key Parameters

Parameter	Symbol	Min.	Typ.	Max	Unit	Conditions	Note
Drain - Source Voltage	V_{DS}			900	v	T_C = 25°C	
Maximum Gate - Source Voltage	$V_{GS(max)}$	-8		+19		Transient	
Operational Gate-Source Voltage	$V_{GS\,op}$		-4/15			Static	Note 1
DC Continuous Drain Current	I_D			73	A	V_{GS} = 15 V, T_C = 25 °C, T_J ≤150 °C	Fig. 19 Note 2
				48		V_{GS} = 15 V, T_C = 100 °C, T_J ≤150 °C	
Pulsed Drain Current	I_{DM}			200		t_{Pmax} limited by T_{jmax} V_{GS} = 15V, T_C = 25 °C	Fig. 22
Power Dissipation	P_D			240	W	T_C = 25 °C, T_J = 150 °C	Fig. 20
Operating Junction and Storage Temperature	T_J, T_{stg}			-40 to +150	°C		
Solder Temperature	T_L			260		According to JEDEC J-STD-020	
Mounting Torque	M_D			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details
Note (2): Verified by design

Electrical Characteristics (T_C = 25℃ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	Note
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	900	—	—	V	V_{GS} = 0 V, I_D = 100 µA	
Gate Threshold Voltage	$V_{GS(th)}$	1.7	2.4	3.5	V	V_{DS} = V_{GS}, I_D = 11 mA	Fig. 11
		—	2.1	—		V_{DS} = V_{GS}, I_D = 11 mA, T_J = 150℃	
Zero Gate Voltage Drain Current	I_{DSS}	—	1	100	µA	V_{DS} = 650 V, V_{GS} = 0 V	
Gate-Source Leakage Current	I_{GSS}	—	10	250	nA	V_{GS} = 15 V, V_{DS} = 0 V	
Drain-Source On-State Resistance	$R_{DS(on)}$	—	30	39	mΩ	V_{GS} = 15 V, I_D = 35 A	Fig. 4, 5, 6
		—	41	—		V_{GS} = 15 V, I_D = 35 A, T_J = 150°C	
Transconductance	g_{fs}	—	23	—	S	V_{DS} = 20 V, I_{DS} = 35 A	Fig. 7
			22			V_{DS} = 20 V, I_{DS} = 35 A, T_J = 150°C	
Input Capacitance	C_{iss}	—	1503	—	pF	V_{GS} = 0 V, V_{DS} = 600 V f = 1 Mhz V_{AC} = 25 mV	Fig. 17, 18
Output Capacitance	C_{oss}	—	144	—			
Reverse Transfer Capacitance	C_{rss}	—	5	—			
Output Capacitance Stored Energy	E_{oss}	—	30	—	µJ		Fig. 16
Turn-On Switching Energy (Body Diode)	E_{on}	—	133	—		V_{DS} = 600 V, V_{GS} = -4 V/15 V, I_D = 35 A, $R_{G(ext)}$ = 2.5 Ω, L= 59 µH, T_J = 150°C	Fig. 26, 29b
Turn Off Switching Energy (Body Diode)	E_{off}	—	111	—			
Turn-On Switching Energy (External Sic Diode)	E_{on}	—	246	—			Fig. 26, 29a
Turn Off Switching Energy (External Sic Diode)	E_{off}	—	99	—			
Turn-On Delay Time	$t_{d(on)}$	—	9	—	ns	V_{DD} = 600 V, V_{GS} = -4 V/15 V I_D = 35 A, $R_{G(ext)}$ = 2.5 Ω, Timing relative to V_{DS} Inductive load	Fig. 27
Rise Time	t_r	—	15	—			
Turn-Off Delay Time	$t_{d(off)}$	—	24	—			
Fall Time	t_f	—	9	—			
Internal Gate Resistance	$R_{G(int)}$	—	3	—	Ω	f = 1 MHz, V_{AC} = 25 mV	
Gate to Source Charge	Q_{gs}	—	20	—	nC	V_{DS} = 600 V, V_{GS} = -4 V/15 V I_D = 35 A Per IEC60747-8-4 pg 21	Fig. 12
Gate to Drain Charge	Q_{gd}	—	26	—			
Total Gate Charge	Q_g	—	74	—			

Reverse Diode Characteristics (T_C = 25℃ unless otherwise specified)

Parameter	Symbol	Typ.	Max.	Unit	Test Conditions	Note
Diode Forward Voltage	V_{SD}	4.5	—	V	V_{GS} = -4 V, I_{SD} = 17.5 A	Fig. 8, 9, 10
		4.0	—		V_{GS} = -4 V, I_{SD} = 17.5 A, T_J = 150°C	
Continuous Diode Forward Current	I_S	—	48	A	V_{GS} = -4 V, T_C = 25°C	
Diode Pulse Current	I_{SM}	—	200		V_{GS} = -4 V, pulse width limited by $T_J$max	
Reverse Recover Time	t_{rr}	24	—	nS	V_{GS} = -4 V, I_{SD} = 35 A, V_R = 600 V dif/dt = 3075 A/µs, T_J = 150°C	
Reverse Recovery Charge	Q_{rr}	536	—	nC		
Peak Reverse Recovery Current	I_{rrm}	35	—	A		

Thermal Characteristics

Parameter	Symbol	Typ.	Max	Unit	Note
Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.48	0.52	°C/W	Fig. 21
Thermal Resistance From Junction to Ambient	$R_{\theta JA}$	—	40		

Typical Performance

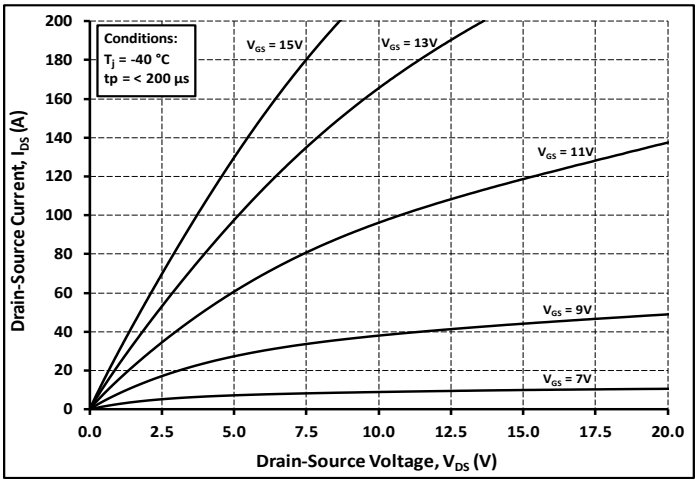


Figure 1. Output Characteristics T_J = -40°C

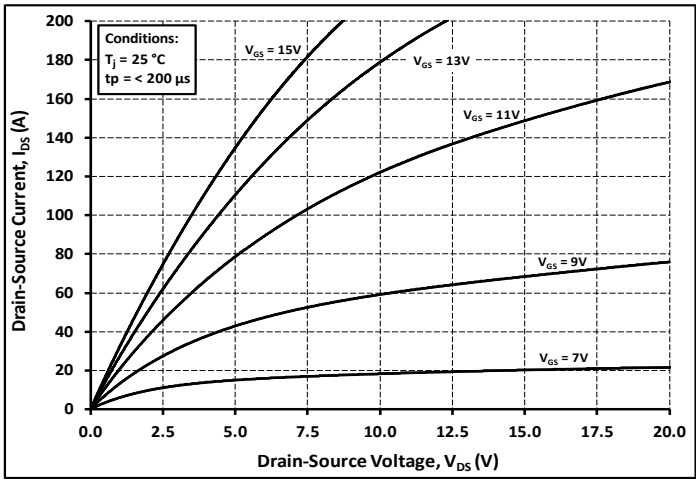


Figure 2. Output Characteristics T_J = 25°C

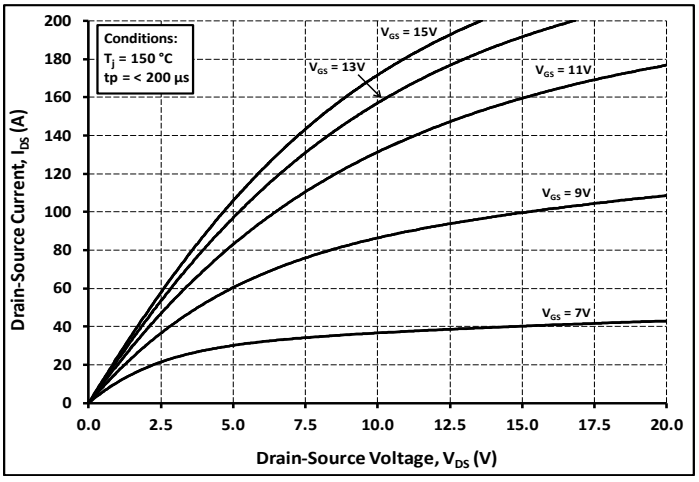


Figure 3. Output Characteristics T_J = 150°C

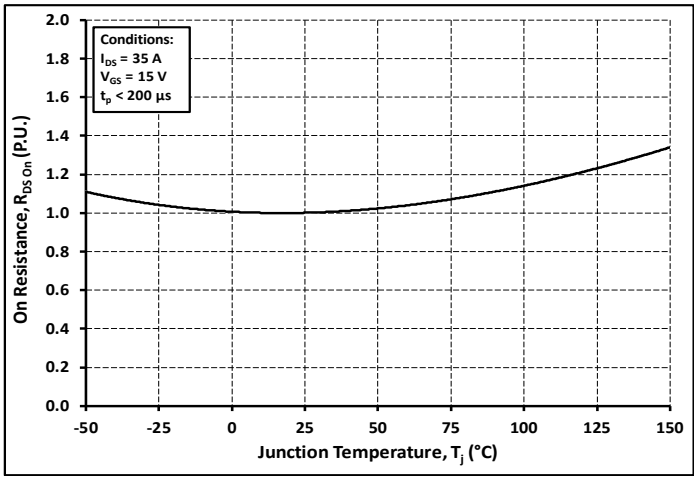


Figure 4. Normalized On-Resistance vs. Temperature

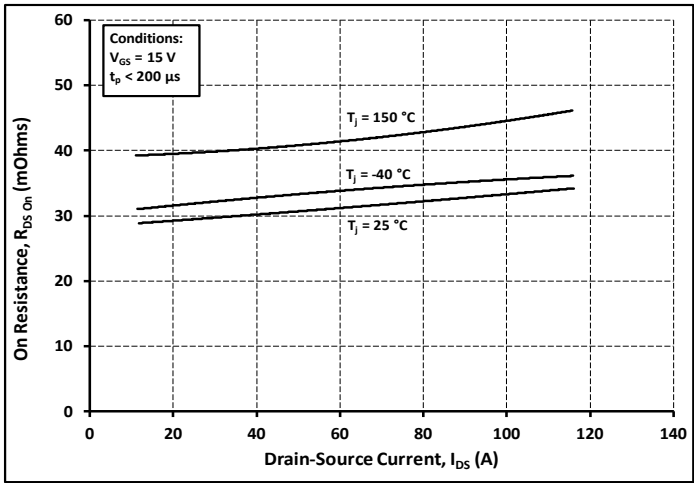


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

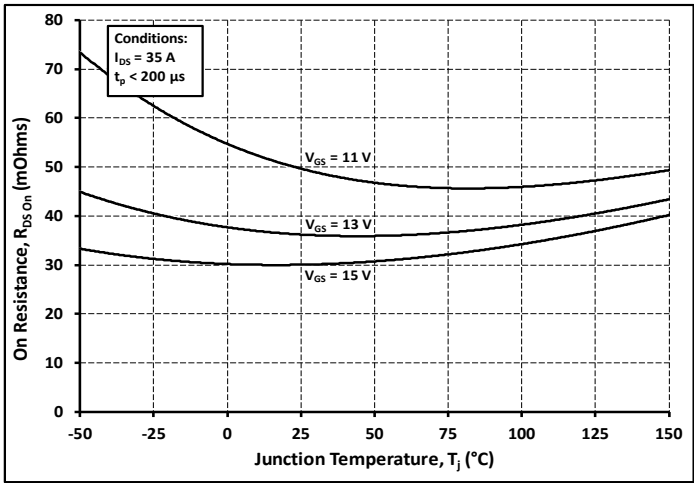


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

Typical Performance

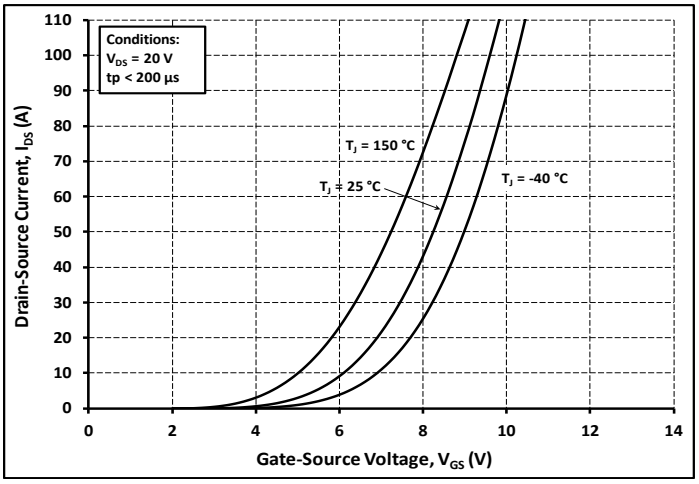


Figure 7. Transfer Characteristic for Various Junction Temperatures

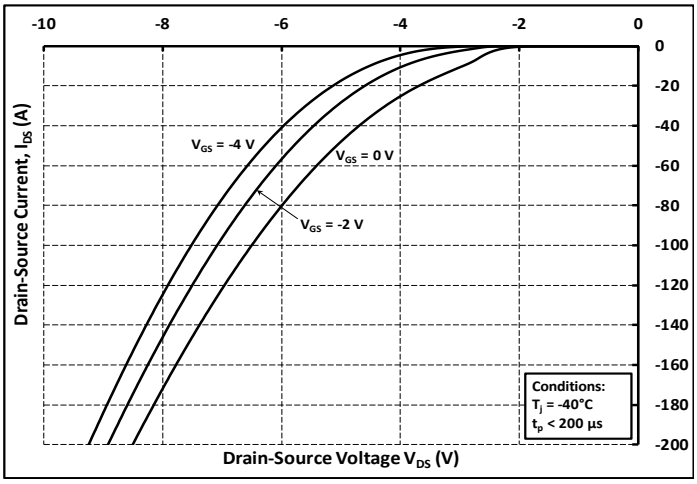


Figure 8. Body Diode Characteristic at -40°C

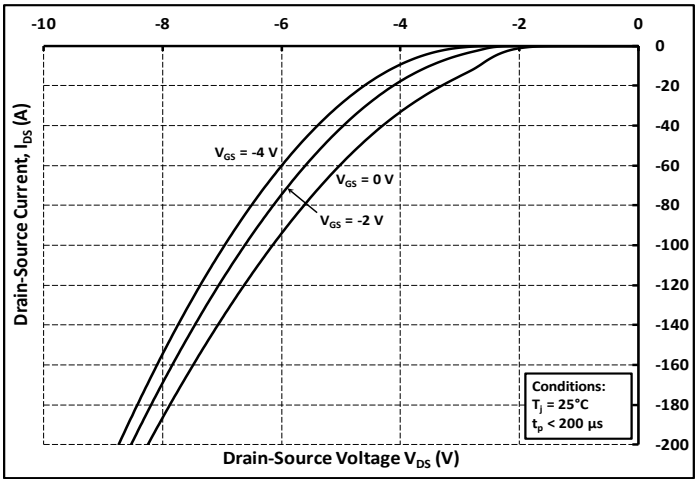


Figure 9. Body Diode Characteristic at 25°C

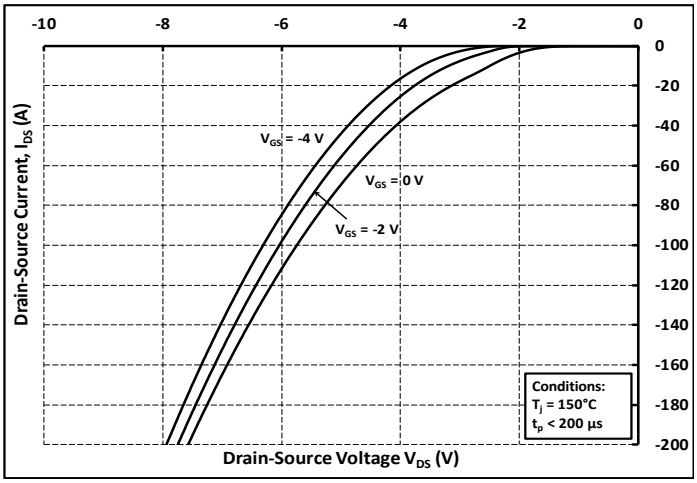


Figure 10. Body Diode Characteristic at 150°C

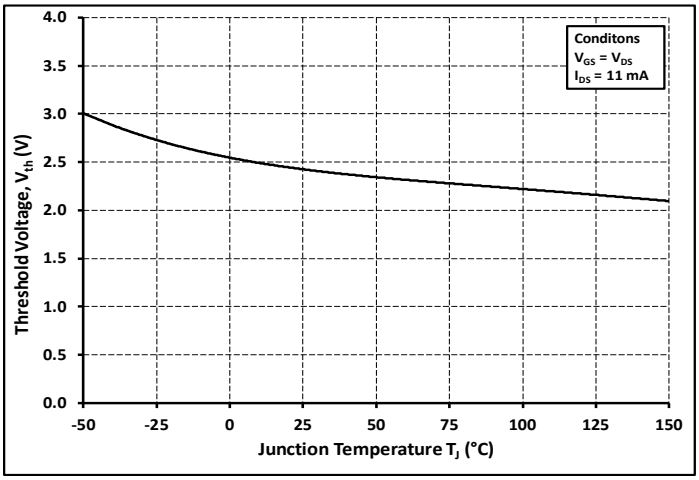


Figure 11. Threshold Voltage vs. Temperature

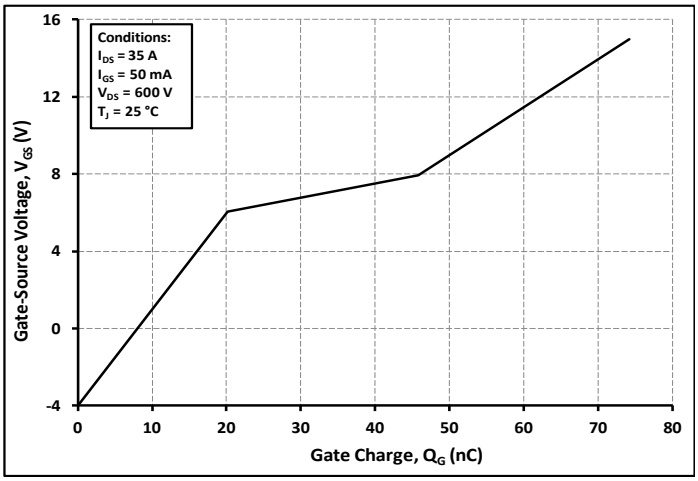


Figure 12. Gate Charge Characteristics

Typical Performance

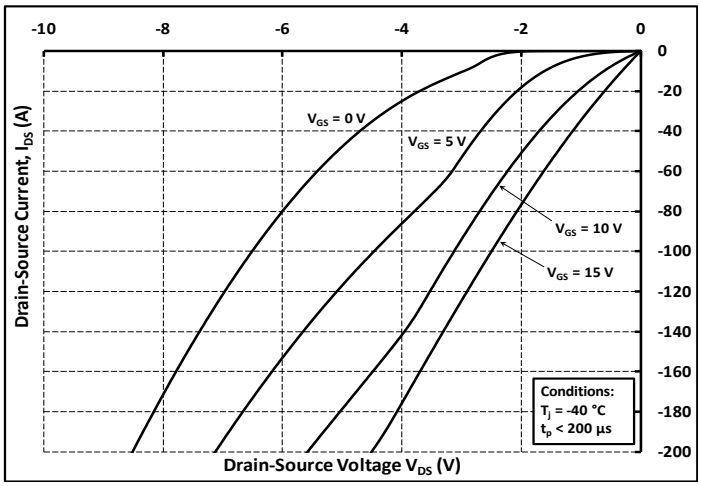


Figure 13. 3rd Quadrant Characteristic at -40°C

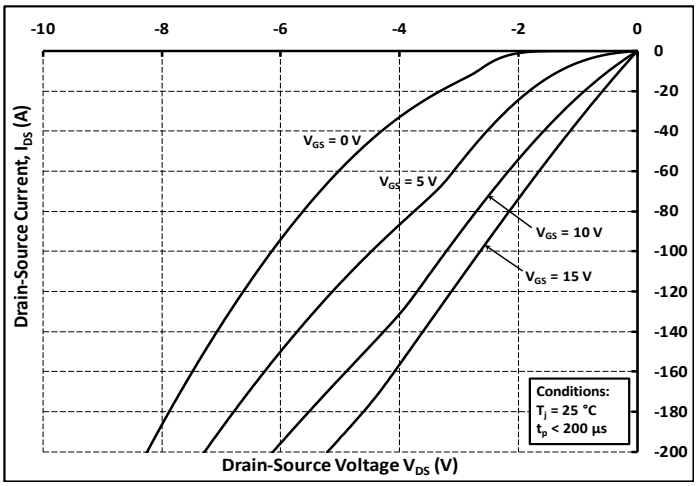


Figure 14. 3rd Quadrant Characteristic at 25°C

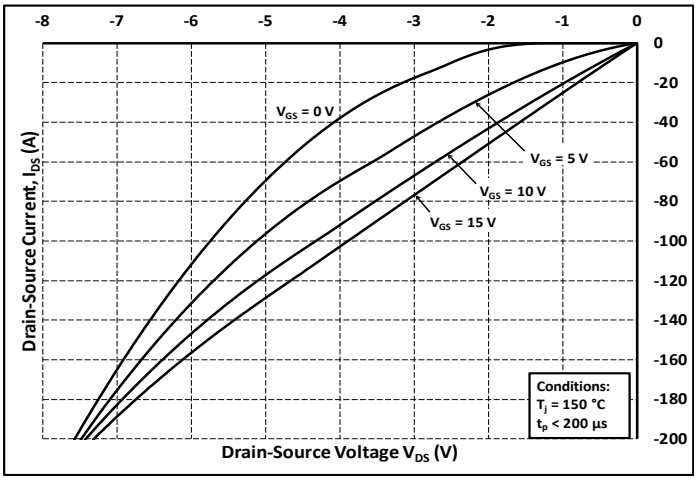


Figure 15. 3rd Quadrant Characteristic at 150°C

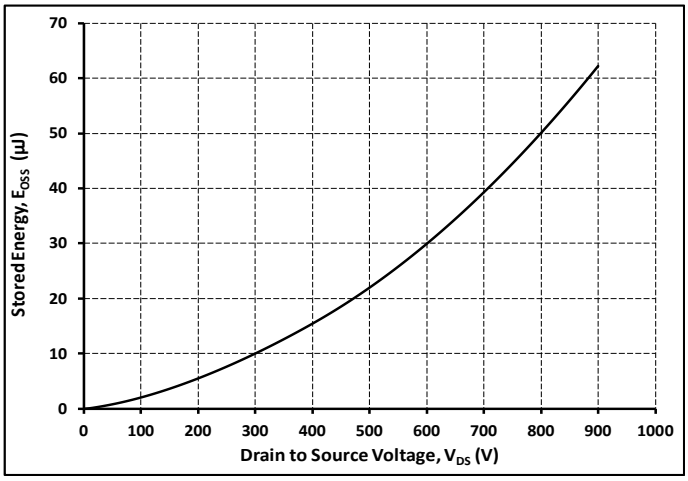


Figure 16. Output Capacitor Stored Energy

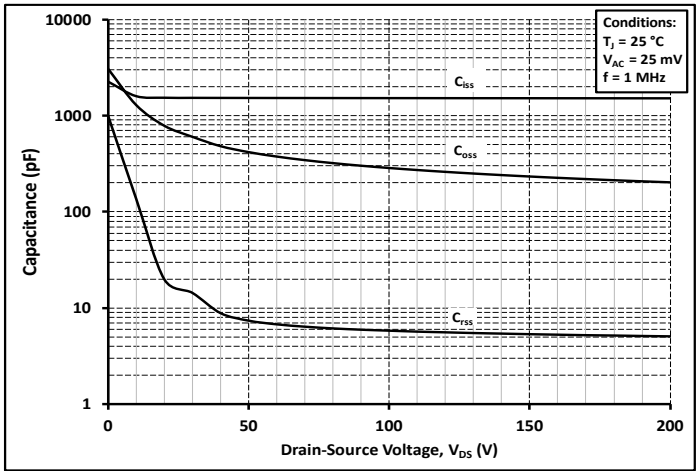


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

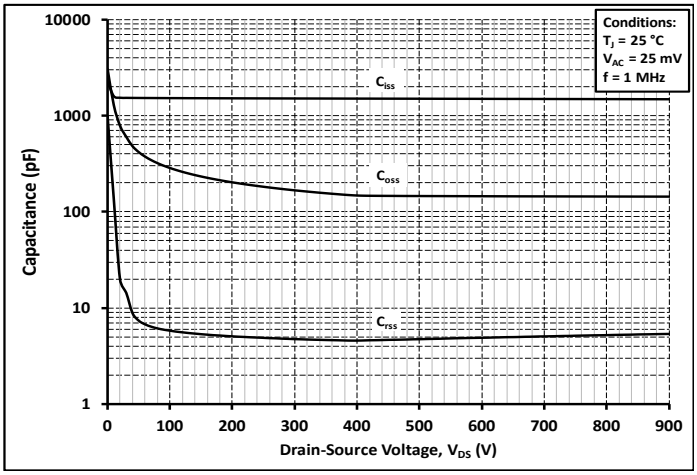


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 900V)

Typical Performance

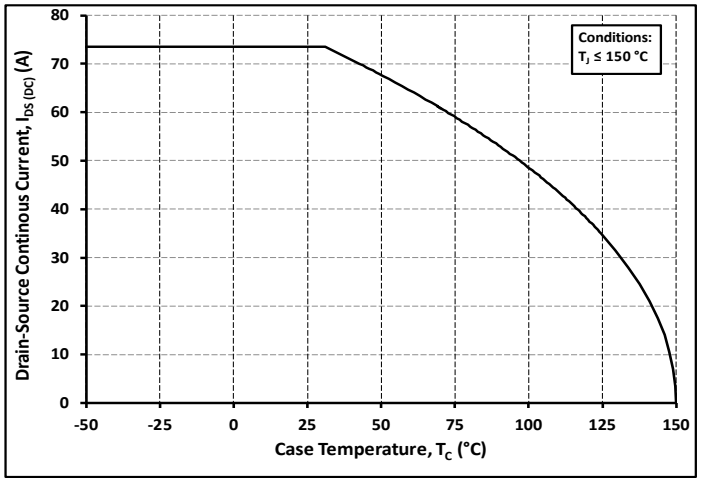


Figure 19. Continuous Drain Current Derating vs. Case Temperature

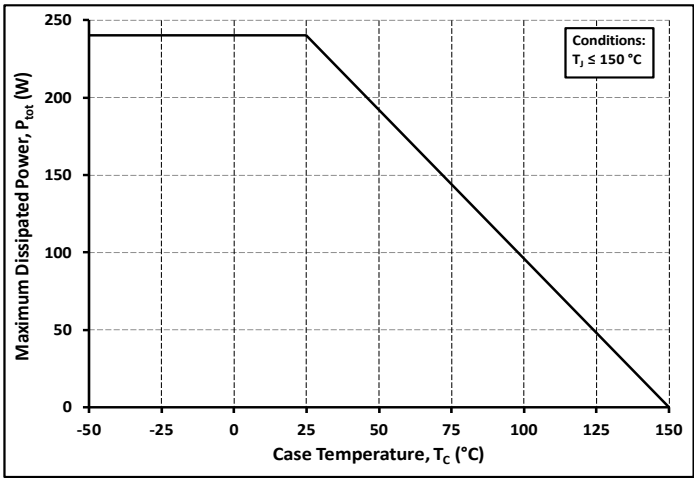


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

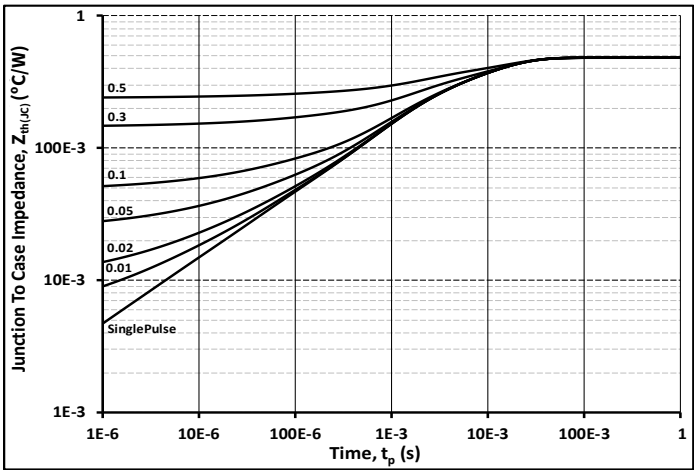


Figure 21. Transient Thermal Impedance (Junction - Case)

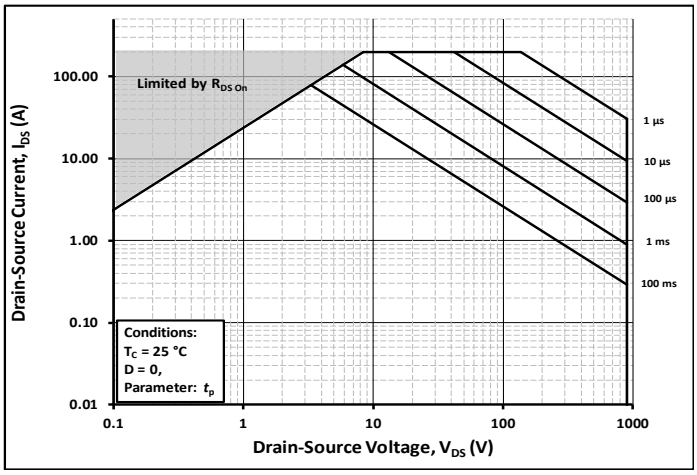


Figure 22. Safe Operating Area

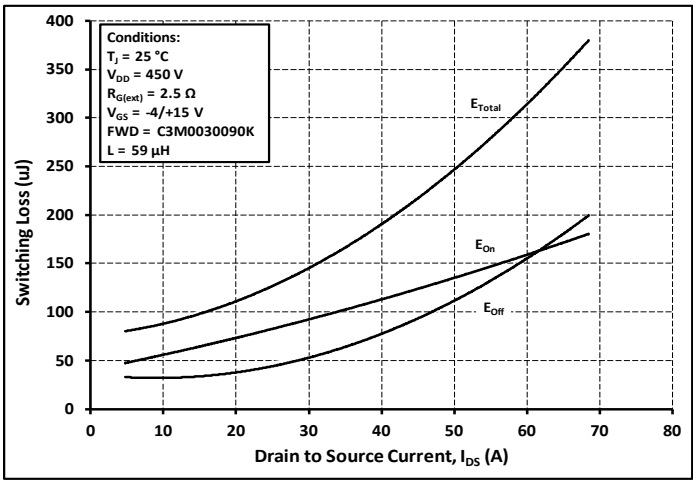


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 450 V)

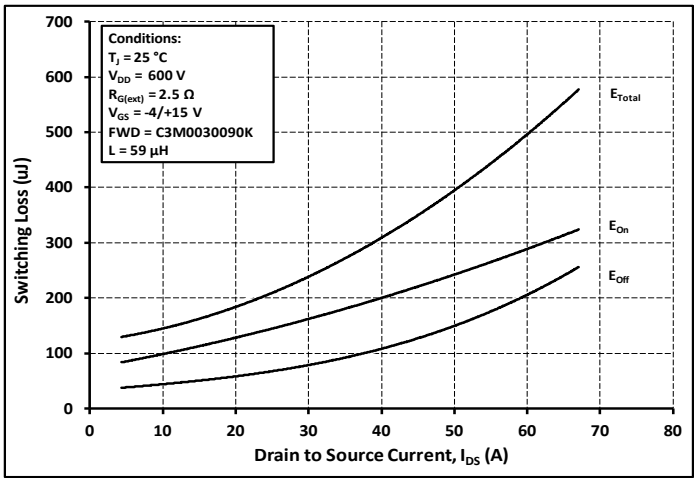


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600 V)

Typical Performance

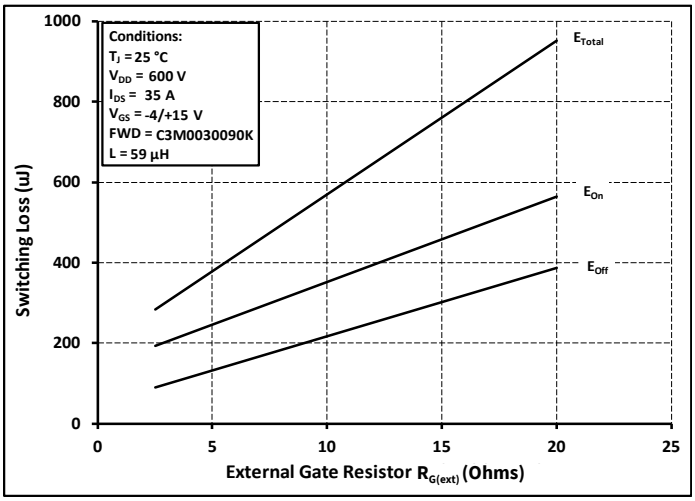


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

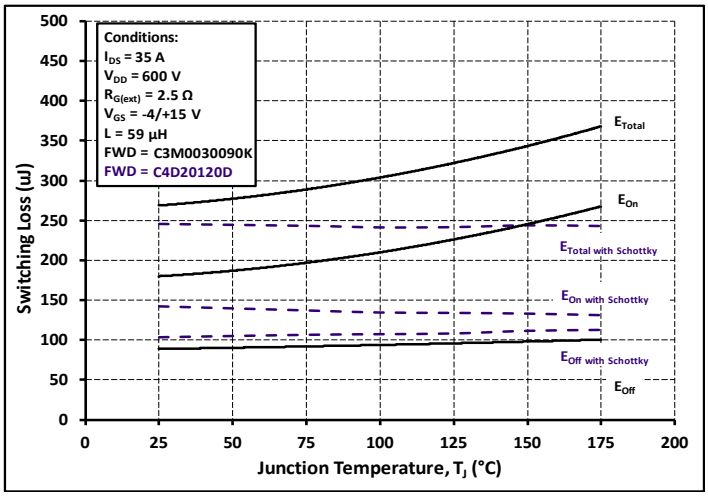


Figure 26. Clamped Inductive Switching Energy vs. Temperature

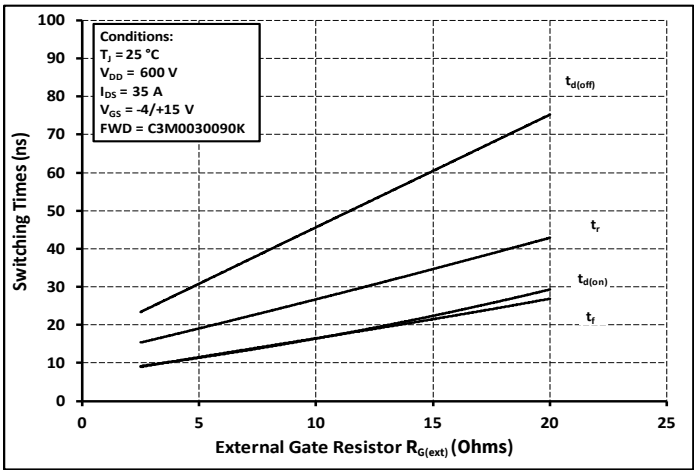


Figure 27. Switching Times vs. $R_{G(ext)}$

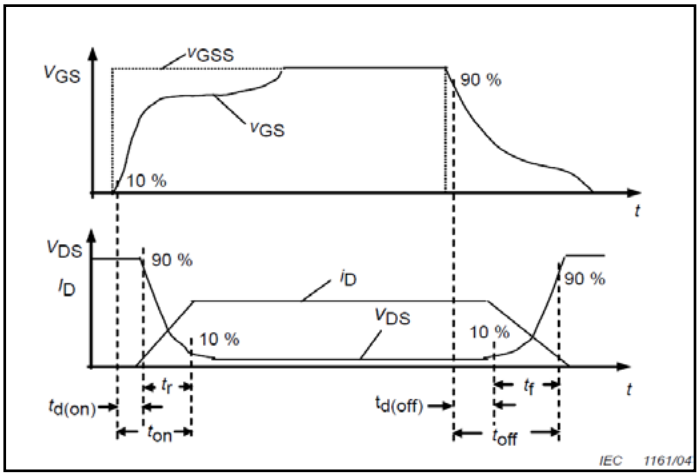


Figure 28. Switching Times Definition

Test Circuit Schematic

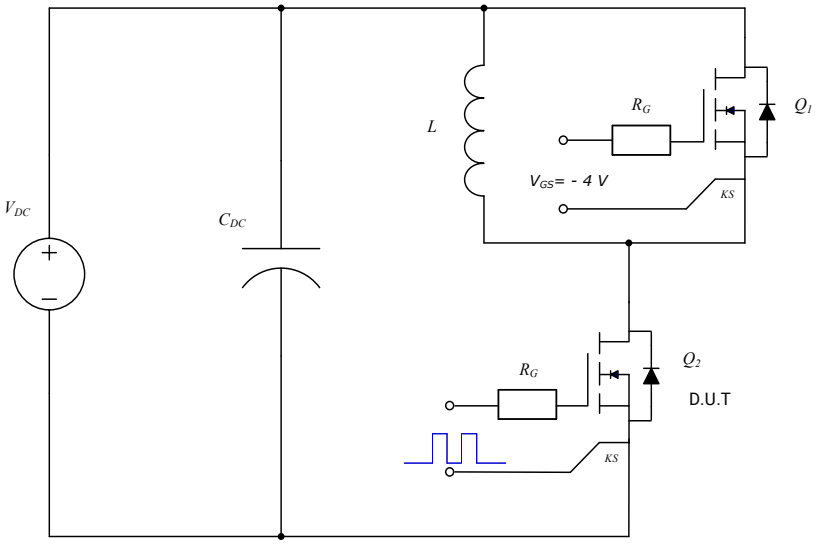


Figure 29a. Clamped Inductive Switching Test Circuit Using MOSFET Intrinsic Body Diode

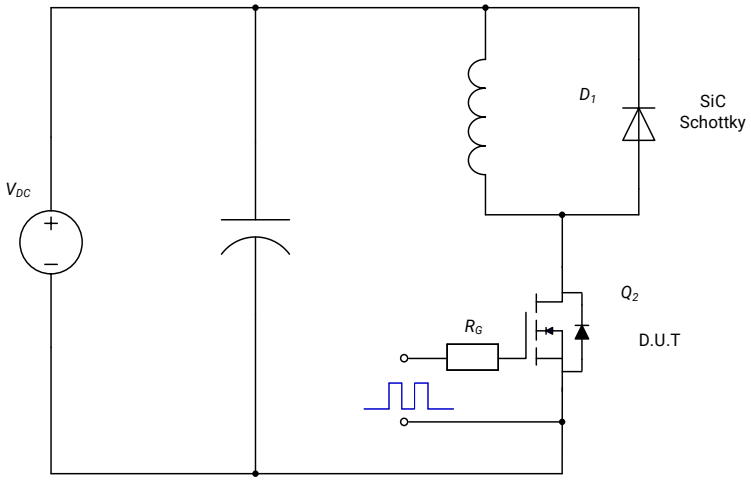
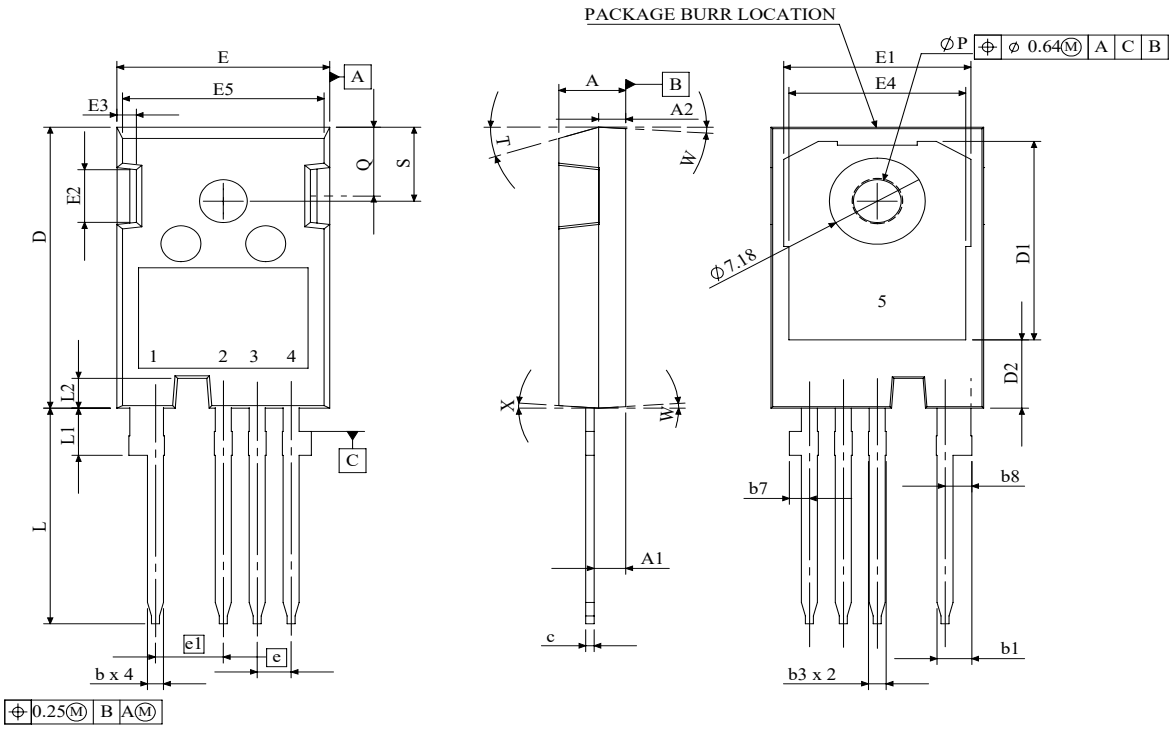


Figure 29b. Clamped Inductive Switching Test Circuit Using SiC Schottky Diode

Package Dimensions – Package TO-247-4L



SYMBOL	MIN (mm)	MAX (mm)
A	4.83	5.21
A1	2.23	2.54
A2	1.91	2.16
b	1.07	1.33
b1	2.39	2.94
b3	1.07	1.60
b7	1.30	1.70
b8	1.80	2.20
c	0.55	0.68
D	23.30	23.63
D1	16.25	17.65
D2	5.55	5.95
E	15.75	16.13
E1	13.1	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
E5	14.65	15.05
e1	5.08 BSC	
L	17.31	17.82
L1	3.97	4.37
L2	2.35	2.65
∅P	3.51	3.65
Q	5.49	6.00
S	6.04	6.30
T	17.5° REF.	
W	3.5° REF.	
X	4° REF.	

1	DRAIN
2	SOURCE
3	DRIVER SOURCE
4	GATE
5	DRAIN

NOTE:
1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
4. BURR OR MOLD FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

Wolfspeed

TITLE: PACKAGE OUTLINE DRAWING: TO-247-4L

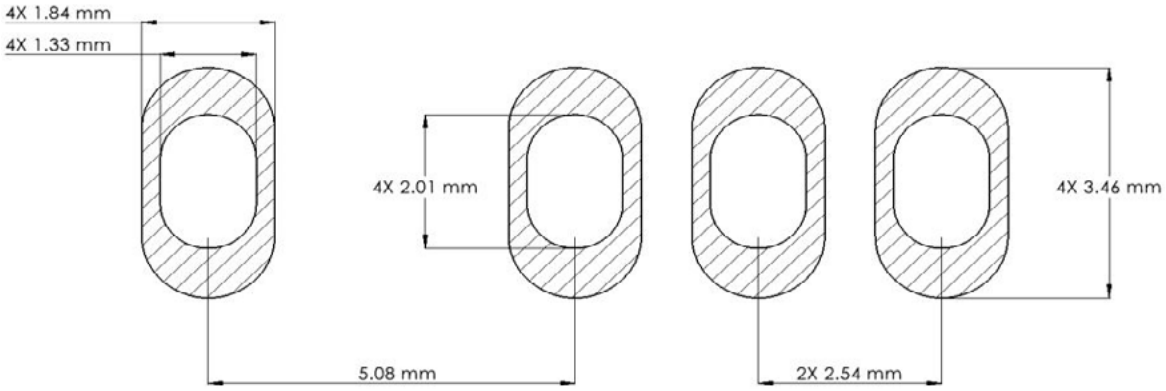
Date: 3/4/24

REVISION NO. 02

A4

PRD 05966 SCALE:1:1 SHEET 1 OF 1

Recommended Solder Pad Layout



Revision History

Current Revision	Date of Release	Description of Changes
4	January-2021	N/A
5	November-2023	Not Released
6	January-2024	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, added Revision History Table, Table 1 layout revised
7	September - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol

Related Links

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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This product has not been designed or tested for use in, and is not intended for use in, any application in which failure of the product would reasonably be expected to cause death, personal injury, or property damage. For purposes of (but without limiting) the foregoing, this product is not designed, intended, or authorized for use as a critical component in equipment implanted into the human body, life-support machines, cardiac defibrillators, and similar emergency medical equipment; air traffic control systems; or equipment used in the planning, construction, maintenance, or operation of nuclear facilities. Notwithstanding any application-specific information, guidance, assistance, or support that Wolfspeed may provide, the buyer of this product is solely responsible for determining the suitability of this product for the buyer's purposes, including without limitation (1) selecting the appropriate Wolfspeed products for the buyer's application, (2) designing, validating, and testing the buyer's application, and (3) ensuring the buyer's application meets applicable standards and any other legal, regulatory, and safety-related requirements.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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